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May 2011

## FAN256 — Dual Low Voltage Comparator

#### **Features**

- Low Supply Current: I<sub>DD</sub>=7µA (Typical)
- Single Power Supply Operation
- Wide Common-Mode Input Voltage Range: Rail-to-Rail
- Push-Pull Output Circuit
- Low Input Bias Current
- Internal Hysteresis
- Packaged in MicroPak™ 8 (1.6mm x 1.6mm)

### **Applications**

- Mobile Phones
- Alarm and Security Systems
- Personal Digital Assistants

### **Description**

The FAN256 is a low-power, dual comparator that typically consumes less than  $10\mu A$  supply current per comparator. Guaranteed to operate at a low voltage of 1.6V and fully operational up to 5.5V, it is convenient for use in 1.8, 3.0V, and 5.0V systems.

The FAN256 has a complementary push-pull P- and N-channel output stage capabile of driving a rail-to-rail output swing with a load ranging up to 5.0mA.

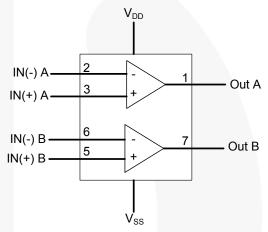


Figure 1. Functional Diagram

### **Ordering Information**

Part Number	Top Mark Temperature Range		Package	Packing Method	
FAN256L8X	N256L8X CP -40 to 85°C 8-Lead, MicroPak™ 1.6mm		8-Lead, MicroPak™ 1.6mm x 1.6mm Package	5000 Units on Tape and Reel	

## **Pin Configuration**

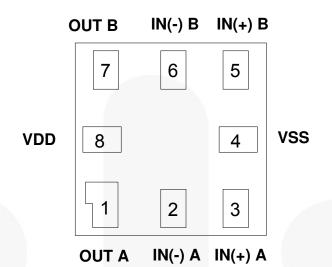


Figure 2. Pin Configuration (Top Through View)

### **Pin Definitions**

Pin#	Name	Description
1	OUT A	Comparator A Output
2	IN(-) A	Inverting Input of Comparator A
3	IN(+) A	Non-Inverting Input of Comparator A
4	VSS	Negative Supply Voltage
5	IN(+) B	Non-Inverting Input of Comparator B
6	IN(-) B	Inverting Input of Comparator B
7	OUT B	Comparator B Output
8	VDD	Positive Supply Voltage

### **Function Table**

Inputs	Outputs
IN(-) > IN(+)	Output LOW
IN(+) > IN(-)	Output HIGH

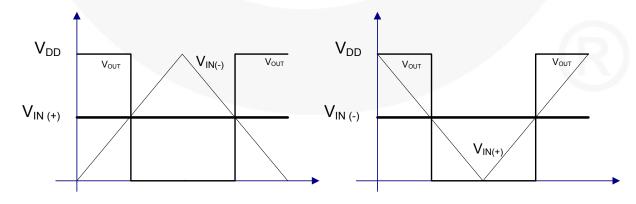


Figure 3. V<sub>IN</sub> vs. V<sub>OUT</sub>

### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Condition	Min.	Max.	Unit	
\/ to\/	Supply Voltage		-3.0	+3.0	V	
$V_{DD}$ to $V_{SS}$	Supply Voltage		0	6.0	V	
DV <sub>IN</sub>	Differential Input Voltage			±6		
V <sub>IN</sub>	Input Voltage			V <sub>SS</sub> to V <sub>DD</sub>	V	
ts	Output Short Circuit Duration <sup>(1)</sup>			Indefinite	S	
TJ	Junction Temperature			+150	°C	
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C	
P <sub>D</sub>	Power Dissipation			226	mW	
ΘJA	Thermal Resistance			287	°C/W	
	IFC C1000 1 2 Cristons FCD	Air Gap		15		
	IEC 61000-4-2 System ESD	Contact		8		
	IFDEC IFSD22 A444 Human Bady	All Pins		8		
ESD	JEDEC JESD22-A114, Human Body Model	Pin to Pin: IN(-), IN(+) to V <sub>DD</sub> or V <sub>SS</sub>		12	kV	
	JEDEC JESD22-C101, Charged Device Model	All Pins		2		

#### Note:

1. The maximum total power dissipation must not be exceeded.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit
\/ to\/	Dower Cumply		-2.75	+2.75	V
V <sub>DD</sub> to V <sub>SS</sub>	Power Supply		0	5.5	V
$V_{DD}$	Power Supply	V <sub>SS</sub> =0V	1.6	5.5	V
$V_{IN}$	Input Voltage			$V_{\text{SS}}$ to $V_{\text{DD}}$	V
		V <sub>DD</sub> =5.0V		5	
I <sub>OH</sub> /I <sub>OL</sub>	Output Sink/Source Current	V <sub>DD</sub> =3.0V		3	mA
		V <sub>DD</sub> =1.6V		1	
T <sub>A</sub>	Operating Temperature, Free Air		-40	+85	°C

### **Electrical Characteristics**

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub> =5.5V, V <sub>5</sub>	<sub>SS</sub> =GND, and T <sub>A</sub> =+25°C					
V <sub>HYS</sub>	Input Hysteresis	V <sub>CM</sub> =0.5V <sub>DD</sub>		4		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pА
It	Input Bias Current			10		pА
$V_{CM}$	Common Mode Input Voltage		V <sub>SS</sub>		$V_{DD}$	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	$V_{CM}=V_{DD}$		68		dB
I <sub>DD</sub>	Supply Current - Per Comparator			7	17	μΑ
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	$\Delta V_{DD}$ =0.5V	45	80		dB
		$V_O = V_{DD}$		60		_
I <sub>OS</sub>	Output Short Circuit Current	V <sub>O</sub> =V <sub>SS</sub>		90		mA
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>SINK</sub> =5.0mA		0.1	0.3	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>SOURCE</sub> =5.0mA	5.2	5.4		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.40		μs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.42		μs
t <sub>TLH</sub>		C <sub>L</sub> =50pF		4.0 5.4		
t <sub>THL</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>					ns
/ <sub>DD</sub> =3V, V <sub>SS</sub> :	=GND, and T <sub>A</sub> =+25°C		<u></u>			
V <sub>HYS</sub>	Input Hysteresis	$V_{CM}=0.5V_{DD}$		4		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pА
l <sub>l</sub>	Input Bias Current			10		pА
V <sub>CM</sub>	Common Mode Input Voltage		V <sub>SS</sub>		$V_{DD}$	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	$V_{CM}=V_{DD}$		60		dB
I <sub>DD</sub>	Supply Current(x) Per Comparator			6	15	μA
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	$\Delta V_{DD}$ =0.5V	45	70		dB
		$V_O = V_{DD}$	1	27	/	mA
los	Output Short Circuit Current	V <sub>O</sub> =V <sub>SS</sub>		35	y i	
V <sub>OL</sub>	Low-Level Output Voltage	I <sub>SINK</sub> =3.0mA		0.15	0.35	V
V <sub>OH</sub>	High-Level Output Voltage	I <sub>SOURCE</sub> =3.0mA	2.65	2.85		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.45		μs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.47		μs
t <sub>TLH</sub>	D	0. 50-5		6.1		
t <sub>THL</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>	C <sub>L</sub> =50pF		6.2		ns

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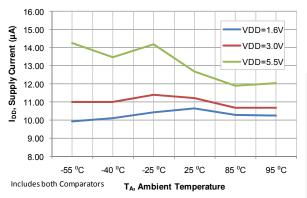
### **Electrical Characteristics**

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub> =1.6V, V <sub>S</sub>	<sub>SS</sub> =GND, and T <sub>A</sub> =+25°C		•			
V <sub>HYS</sub>	Input Hysteresis	V <sub>CM</sub> =0.5V <sub>DD</sub>		3.5		mV
V <sub>IO</sub>	Input Offset Voltage <sup>(2)</sup>	V <sub>CM</sub> =0.5V <sub>DD</sub>	-15	±1	+15	mV
I <sub>IO</sub>	Input Offset Current			10		pА
l <sub>l</sub>	Input Bias Current			10		pА
$V_{CM}$	Common Mode Input Voltage		V <sub>SS</sub>		$V_{DD}$	V
CMRR	Common Mode Rejection Ratio <sup>(3)</sup>	V <sub>CM</sub> =V <sub>DD</sub>		56		dB
I <sub>DD</sub>	Supply Current(x) Per Comparator			5	13	μA
PSRR	Power Supply Rejection Ratio <sup>(3)</sup>	$\Delta V_{DD}$ =0.5V	45	70		dB
	Output Short Circuit Current	V <sub>O</sub> =V <sub>DD</sub>		5.5		mA
los		V <sub>O</sub> =V <sub>SS</sub>		7.5		
$V_{OL}$	Low-Level Output Voltage	I <sub>SINK</sub> =1.0mA		0.15	0.25	V
$V_{OH}$	High-Level Output Voltage	I <sub>SOURCE</sub> =1.0mA	1.35	1.50		V
t <sub>PLH</sub>	Propagation Delay (Turn-On)	Overdrive=20mV, C <sub>L</sub> =15pF		0.52		μs
t <sub>PHL</sub>	Propagation Delay (Turn-Off)	Overdrive=20mV, C <sub>L</sub> =15pF		0.54		μs
t <sub>TLH</sub>	Despense Time Output Dies /F-II(4)	0.50.5		16.5		200
t <sub>THL</sub>	Response Time, Output Rise/Fall <sup>(4)</sup>	C <sub>L</sub> =50pF		13.0		ns

- Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.

  Guaranteed by design and characterization data
  Input signal: 1kHz, square-wave signal with 10ns edge rate.

### **Typical Performance Characteristics**



900 800 1.6 VDD 700 3.0 VDD 600 £ 5.5 VDD 500 ၁ 400 300 200 100 0.01 Temp. =25C 0.1 10 100 1000 Frequency (Khz) C<sub>L</sub> = 15pF

Figure 4. Supply Current vs. Temperature

16 14 I<sub>DD</sub>, Supply Current (μA) 12 8 6 25 °C 4 85 °C O 1.5 2.5 3 3.5 \* Data includes V<sub>DD</sub>, Supply Voltage (V) both comparators

Figure 5. Supply Current vs. Output Transition Frequency

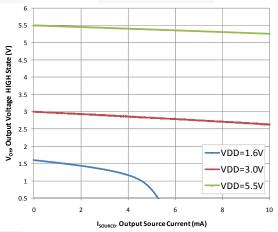


Figure 6. Supply Current vs. Supply Voltage

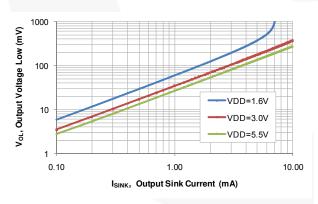


Figure 7. Output HIGH vs. Output Drive Current

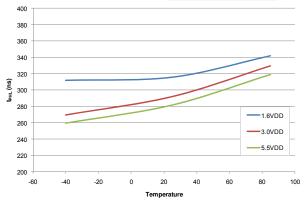
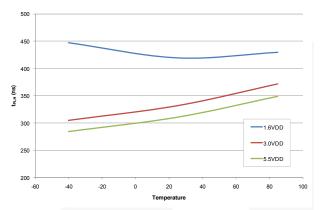


Figure 8. Output LOW vs. Output Drive Current

Figure 9. Propagation Delay (t<sub>PHL</sub>) vs. Temperature

### **Typical Performance Characteristics** (Continued)



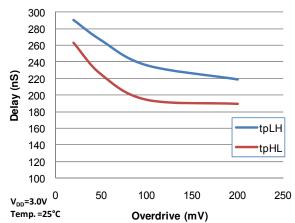


Figure 10.Propagation Delay (t<sub>PLH</sub>) vs. Temperature

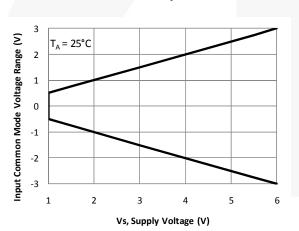


Figure 11. Propagation Delay vs. Input Overdrive

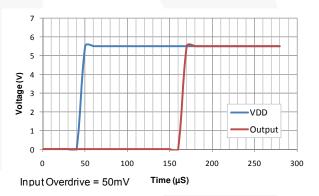
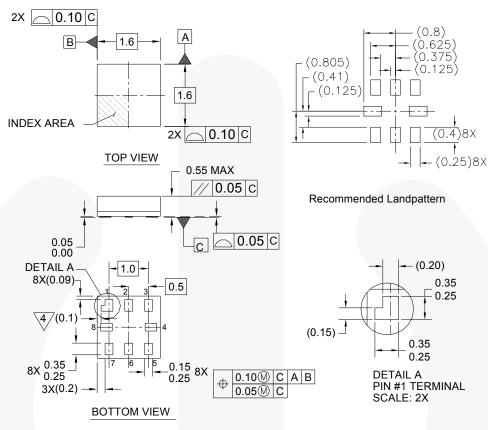


Figure 12. Input Common Mode Voltage Range vs. Supply Voltage

Figure 13. Power-Up Delay

### **Physical Dimensions**



#### Notes:

- 1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y.14M-1994
- 4/PIN 1 FLAG, END OF PACKAGE OFFSET
- 5. DRAWING FILE NAME: MKT-MAC08AREV4

MAC08AREV4

Figure 14. 8-Lead, MicroPak™ 1.6mm Wide

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